DATA SHEET

● DEVICE NUMBER: ORH-R36G

(For: 客户)

SHEET	1	2	3	4	5	6	7	8	9	CONTENTS
2010.06.15	1.0	1.0	1.0	1.0	1.0	1.0	1.0	1.0	1.0	Original Released

深圳市奥伦德光电有限公司

SHENZHEN ORIENT OPTO-ELECTRONICS CO.,LTD.

深圳市宝安区西乡鹤洲鸿图工业园 1 栋

Block 1, Hongtu industry Park, Hezhou, xixiang Town, Baoan district, Shenzhen, P.R.C

Tel: 0755-27478985 29980591

Fax: 0755-29980950

E-Mail:saleselec@ orient-opto.com salesdev@ orient-opto.com

www.orient-opto.com.



ORH-R36G

CONTENTS

1.	Features	 2/9
2.	Outline dimensions	 2/9
3.	Applications	 -3/9
4.	Absolute Maximum Ratings	 3/9
5.	Electro-Optical characteristics	 -3/9
6.	Typical Characteristic Curve	 -4/9
7.	Reliability Test Items and Conditions	 -5/9
8.	Soldering	 6/9
9.	Handling	 6/9
10.	Notes for designing	 7/9
11.	Storage	 7/9
12.	Package and Label of Products	 7/9
13.	Bin Limits	 8/9
14.	Tapping and packaging specifications	 -9/9
15.	Package Method	 -9/9

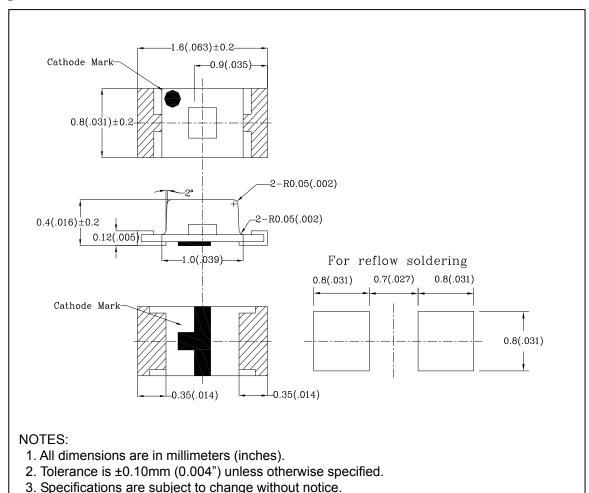


ORH-R36G

Features:

- 1. Chip material: AlGaInP/GaAs
- 2. Emitted Color: Super Orange Red.
- 3. Lens Appearance: Water Clear.
- 4. Mono-color type.
- 5. 1.6x0.8x0.4mm (0603) standard package.
- 6. Suitable for all SMT assembly methods.
- 7. Compatible with infrared and vapor phase reflow solder process.
- 8. Compatible with automatic placement equipment.
- 9. This product doesn't contain restriction Substance, comply ROHS standard.

Package Dimensions:





ORH-R36G

Applications:

1. Automotive: Dashboards, stop lamps, turn signals.

2. Backlighting: LCDs, Key pads advertising.

3. Status indicators: Comsumer & industrial electronics.

4. General use.

■ Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation Pd		100	mW
Forward Current	l _F	30	mA
Peak Forward Current *1	I _{FP}	100	mA
Operating Temperature Topr		-25°℃~80°℃	-
Storage Temperature	Tstg	-30°℃~85°℃	-
Soldering Temperature Tsol		See Page 6	-

 $[\]ensuremath{ \star 1}$ Condition for I_FP is pulse of 1/10 duty and 0.1msec width.

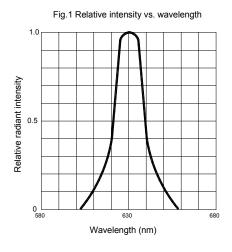
● Electrical and optical characteristics(Ta=25°C)

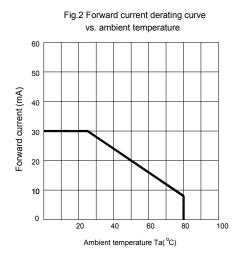
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	I _F =5mA I _F =20mA	-	1.8 2.0	2.4 2.6	V
Luminous Intensity	lv	I _F =5mA I _F =20mA	12.3 70	25 90	-	mcd
Reverse Current	I_R	V _R =5V	-	-	100	μΑ
Peak Wave Length	λρ	I _F =5mA I _F =20mA	-	630	-	nm
Dominant Wave Length	λd	I _F =5mA I _F =20mA	615 610		625 620	nm
Spectral Line Half-width	Δλ	I _F =5mA I _F =20mA	-	17	-	nm
Veiwing Angle	2θ _{1/2}	I _F =5mA I _F =20mA	-	120		deg

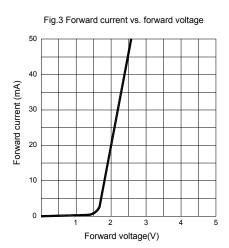


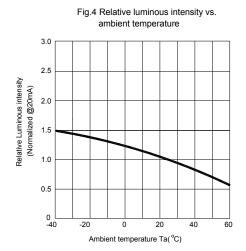
ORH-R36G

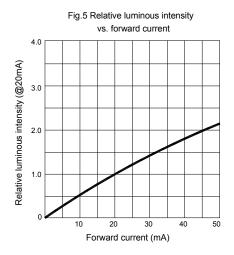
Typical Electro-Optical Characteristics Curves

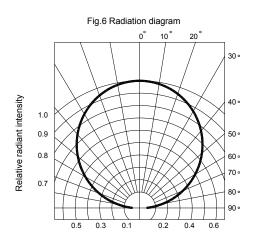














ORH-R36G

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	$V_{F}(V)$	I _F =20mA	Over Ux1.2
Reverse current	$I_R(uA)$	V _R =5V	Over Ux2
Luminous intensity	lv (mcd)	I _F =20mA	Below SX0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	Connect with a power If=20mA Ta=Under room temperature Test time=1,000hrs	0/20
Endurance	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+65°C±5°C RH=90%-95% Test time=240hrs	0/20
Test	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85℃±5℃ Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-35°C±5°C Test time=1,000hrs	0/20
	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	-35°C ~ $+25$ °C ~ $+85$ °C ~ $+25$ °C 60min 20min 60min 20min Test Time=5cycle	0/20
Environmental Test	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-35°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating: 140°C-160°C, within 2 minutes. Operation heating: 260°C (Max.), within 10seconds. (Max.)	0/20



ORH-R36G

Soldering :

1. Manual Of Soldering

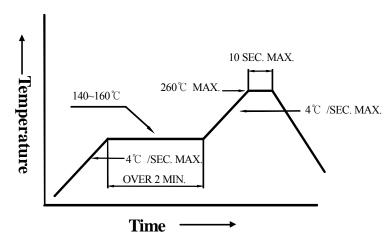
The temperature of the iron tip should not be higher than 300° C (572°F) and Soldering within 3 seconds per solder-land is to be observed.

2. Reflow Soldering

Preheating: 140°C ~160°C ±5°C, within 2 minutes.

Operation heating: 260°C (Max.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).

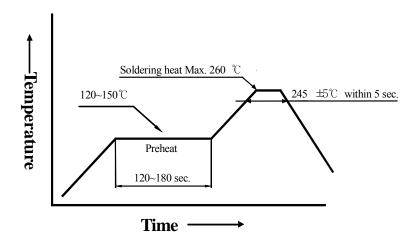


3. DIP soldering (Wave Soldering):

Preheating : 120° C \sim 150 $^{\circ}$ C, within 120 \sim 180 sec.

Operation heating: 245°C±5°C within 5 sec.260°C (Max)

Gradual Cooling (Avoid quenching).



Handling:

Care must be taken not to cause to the epoxy resin portion of ORIENT LEDs while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of ORIENT LEDs with hard or sharp article such as the sand blast and the metal hook.



ORH-R36G

Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the ORIENT LEDs within the rated figures. Also, caution should be taken not to overload ORIENT LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the ORIENT LEDs.

Storage:

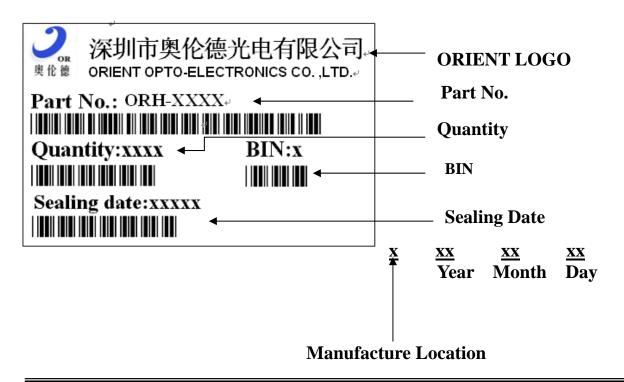
In order to avoid the absorption of moisture, it is recommended to solder ORIENT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5° C- 30° C(41° F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
- a. Completed within 168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if: (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at $60^{\circ}\text{C} \pm 3^{\circ}\text{C}$.

Package and Label of Products:

- (1) Package: Products are packed in one bag of 4000 pcs (one taping reel) and a label is attached on each bag.
- (2) Label:



ORH-R36G

Bin Limits

Intensity Bin Limits (At 20mA)

BIN CODE	Min. (mcd)	Max. (mcd)
N	42	63
Р	63	94
Q	94	140
R	140	210

Tolerance for each Bin limit is $\pm 15\%$.

Color Bin Limits (At 20mA)

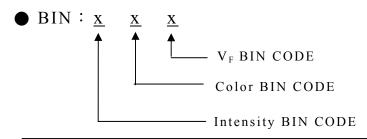
BIN CODE	Min. (nm)	Max. (nm)	
6	620	625	
7	625	630	

Tolerance for each Bin limit is ± 1 nm.

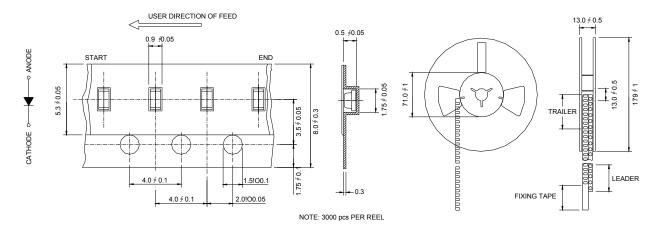
V_F Bin Limits (At 20mA)

BIN CODE	Min.(v)	Max.(v)
А	1.6	1.8
В	1.8	2.0
С	2.0	2.2
D	2.2	2.4
E	2.6	2.8

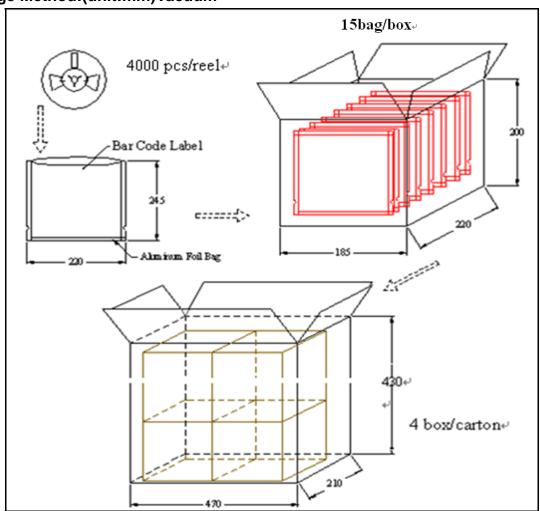
Tolerance for each Bin limit is ± 0.05 V.



Tapping and packaging specifications(Units: mm)



● Package Method:(unit:mm) Vacuum



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard LEDs - SMD category:

Click to view products by Orient manufacturer:

Other Similar products are found below:

LTST-C190KYKT LTST-C19GD2WT LTST-N683GBEW LTW-170ZDC LTW-M140SZS40 598-8110-100F 598-8170-100F 598-8610202F AAAF5060QBFSEEZGS HLMA-QG00-S0021 ALMD-LB36-SV002 APT1608QGW EAST2012YA0 EASV1803BA0 LG M67KH1J2-24-0-2-R18-Z SML-512VWT86A SML-LX0606SISUGC/A SML-LXL1307SRC-TR SML-LXR851SIUPGUBC LT1ED53A

AM27ZGC03 APB3025SGNC APFA3010SURKCGKQBDC APHK1608VGCA APT2012QGW CLX6D-FKB-CN1R1H1BB7D3D3 LTST008BGEW LTST-C250KGKT LTW-010DCG LTW-020ZDCG LTW-21TS5 LTW-220DS5 598-8330-117F SML-LX0402IC-TR

CMDA20AYAA7D1S CMDA16AYDR7A1X 91-21SYGD/S530-E2/TR7 598-8040-100F 598-8070-100F 598-8140-100F 598-8610-200F

EAST2012GA0 SML-LXL1209SYC/ATR EAST2012RA0 EAST1608RGBA0 CMD91-21VRC/TR7 SML-LXR851SGSIC-TR SML512PWT86A SMF-2432GYC-TR HSMQ-C197